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STS17NF3LL

N-channel 30V - 0.0045Ω - 17A - SO-8
STripFET™ II Power MOSFET for DC-DC conversion

General features

Type	V _{DSS}	R _{DS(on)}	I _D
STS17NF3LL	30V	<0.0055Ω	17A

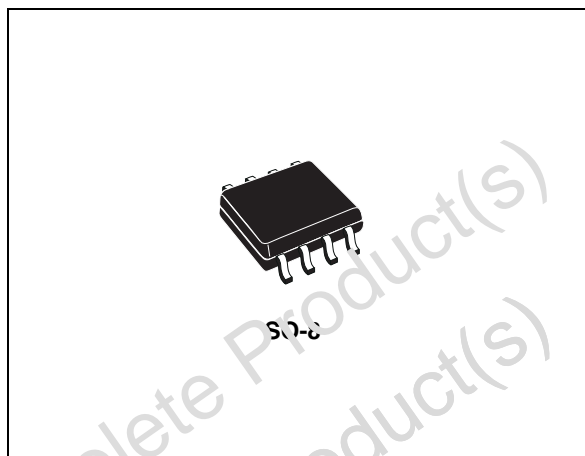
- Optimal R_{DS(on)} x Q_g trade-off @ 4.5V
- Conduction losses reduced
- Switching losses reduced

Description

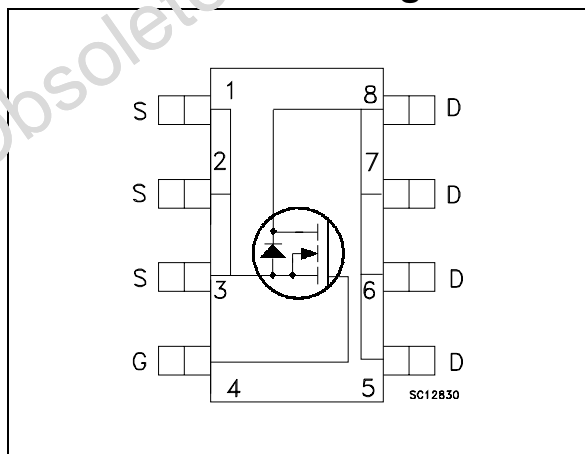
This application specific Power MOSFET is the second generation of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. Such features make it the best choice in high efficiency DC-DC converters for Telecom and computer industries.

Applications

- Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS17NF3LL	S17NF3LL	SO-8	Tape & reel

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Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V
V_{GS}	Gate-source voltage	± 18	V
I_D	Drain current (continuous) at $T_C = 25^\circ\text{C}$	17	A
I_D	Drain current (continuous) at $T_C = 100^\circ\text{C}$	12	A
$I_{DM}^{(1)}$	Drain current (pulsed)	68	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	3.2	W

1. Pulse width limited by safe operating area

Table 2. Thermal data

$R_{thj-amb}$	Thermal resistance junction-ambient max ⁽¹⁾	47	$^\circ\text{C/W}$
$R_{thj-lead}$	Thermal resistance junction-leads max	16	$^\circ\text{C/W}$
T_j	Maximum operating junction temperature	-55 to 175	$^\circ\text{C}$
T_{stg}	Storage temperature	-55 to 175	$^\circ\text{C}$

1. When mounted on FR-4 board of 1in², 2oz Cu, $t < 10\text{sec}$

Electrical characteristics

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2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250μA, V _{GS} = 0	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = max rating V _{DS} = max rating, T _C = 125°C			1 10	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 18V			± 100	nA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 250μA	1			V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 8.5A V _{GS} = 4.5V, I _D = 8.5A		0.0045 0.0055	0.0055 0.007	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
g _{fs} (1)	Forward transconductance	V _{DS} = 10V, I _D = 8.5A		37		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25V, f = 1MHz, V _{GS} = 0		2160 614 98		pF pF pF
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V _{DD} = 15V, I _D = 8.5A R _G = 4.7Ω V _{GS} = 4.5V (see Figure 13)		23.5 39 47.5 37		ns ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} = 24V, I _D = 12.5A, V _{GS} = 4.5V, R _G = 4.7Ω (see Figure 14)		26 7 12	35	nC nC nC

1. Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.

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Electrical characteristics

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD} $I_{SDM}^{(1)}$	Source-drain current Source-drain current (pulsed)				17 68	A A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 17A, V_{GS} = 0$			1.2	V
t_{rr} Q_{rr} I_{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 17A, di/dt = 100A/\mu s,$ $V_{DD} = 15V; T_j = 150^\circ C$ (see Figure 15)		39 45 2.3		ns nC A

1. Pulse width limited by safe operating area.
2. Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

Electrical characteristics

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2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

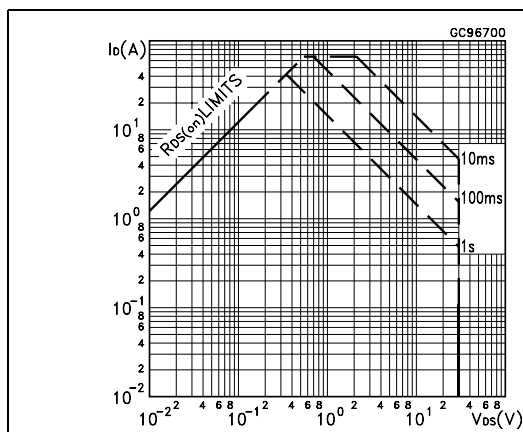


Figure 2. Thermal impedance

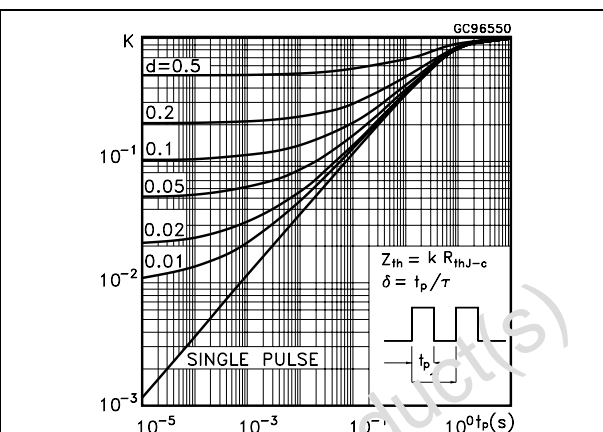


Figure 3. Output characteristics

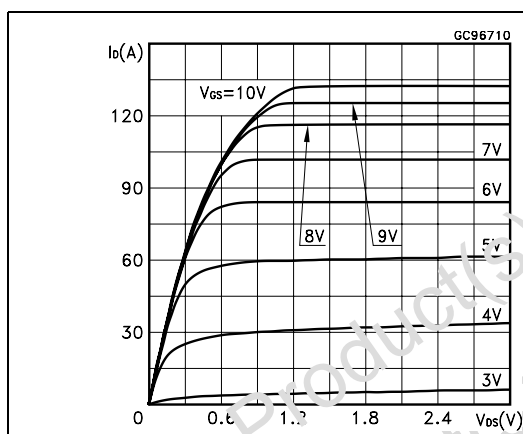


Figure 4. Transfer characteristics

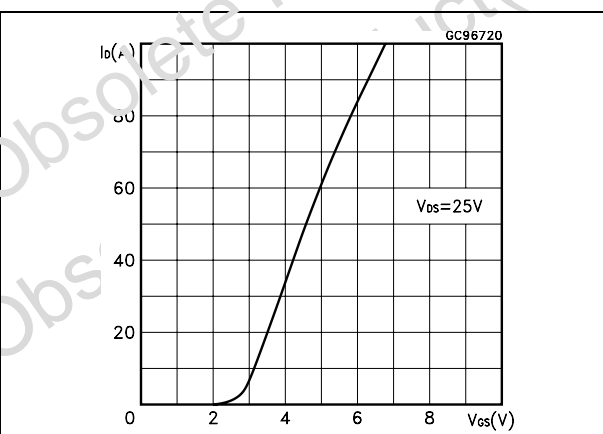


Figure 5. Transconductance

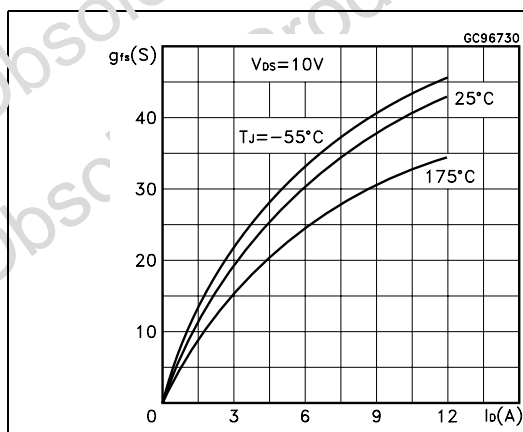
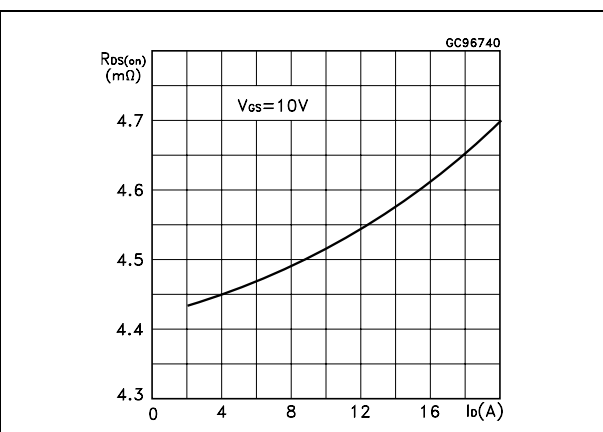


Figure 6. Static drain-source on resistance



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Electrical characteristics

Figure 7. Gate charge vs gate-source voltage **Figure 8. Capacitance variations**

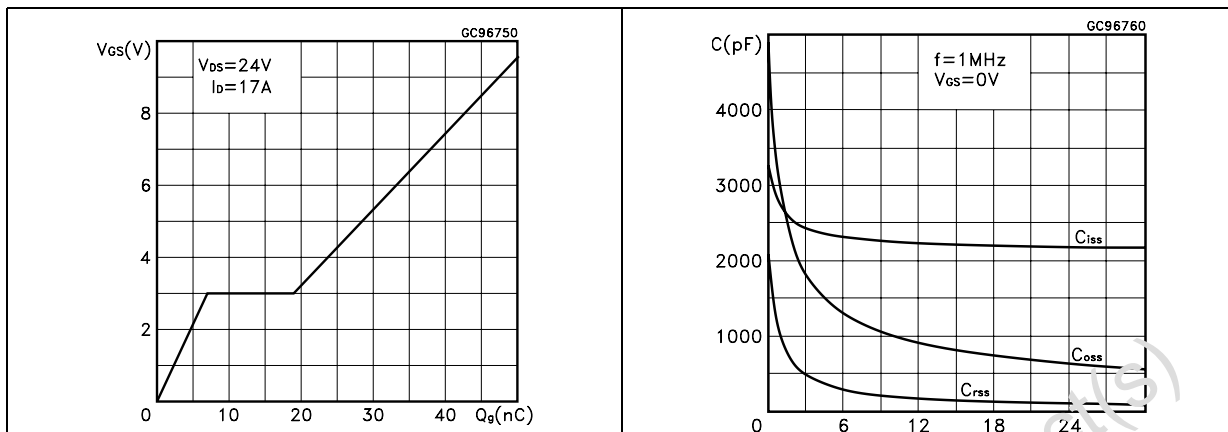


Figure 9. Normalized gate threshold voltage vs temperature **Figure 10. Normalized on resistance vs temperature**

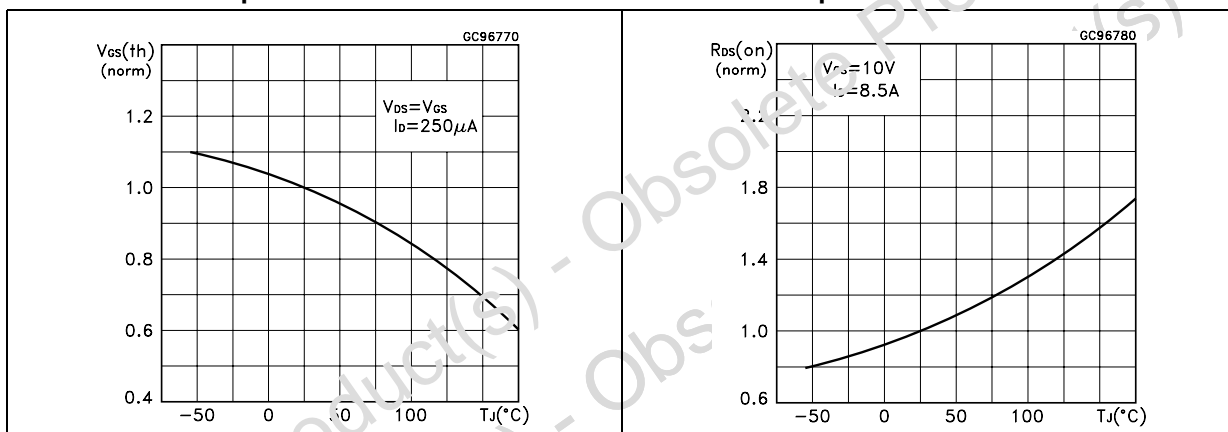
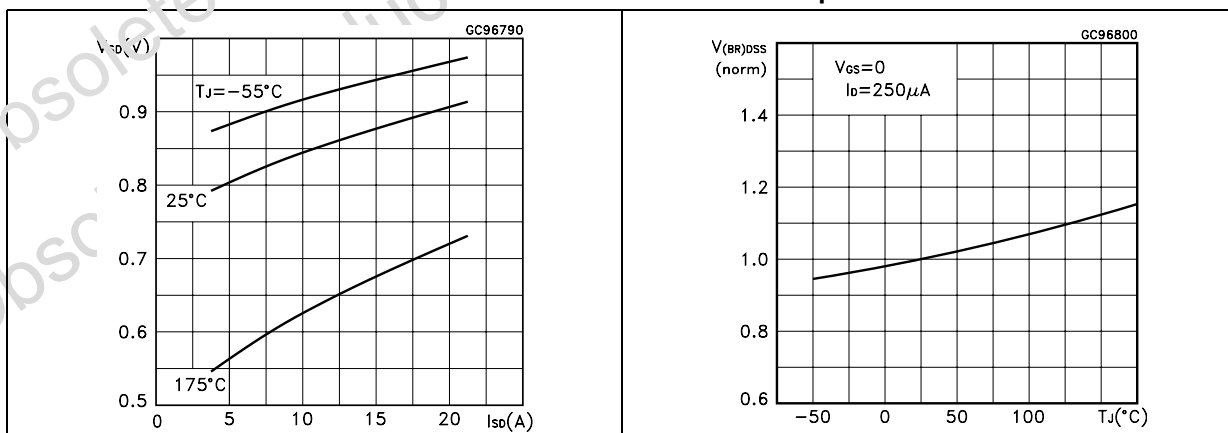


Figure 11. Source-drain diode forward characteristics **Figure 12. Normalized breakdown voltage vs temperature**



Test circuit

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3 Test circuit

Figure 13. Switching times test circuit for resistive load

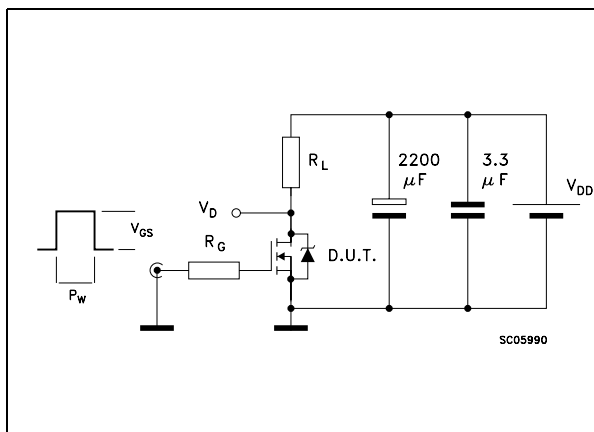


Figure 14. Gate charge test circuit

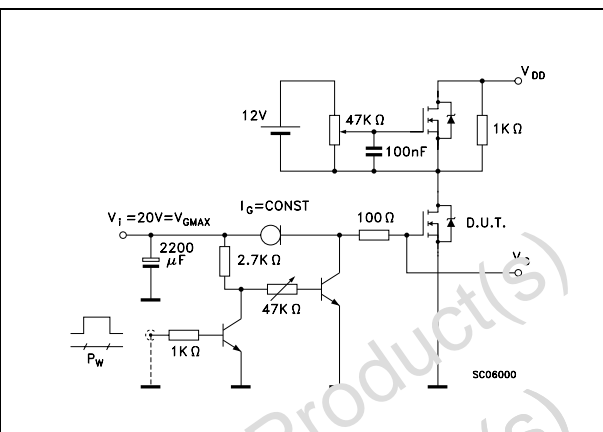


Figure 15. Test circuit for inductive load switching and diode recovery times

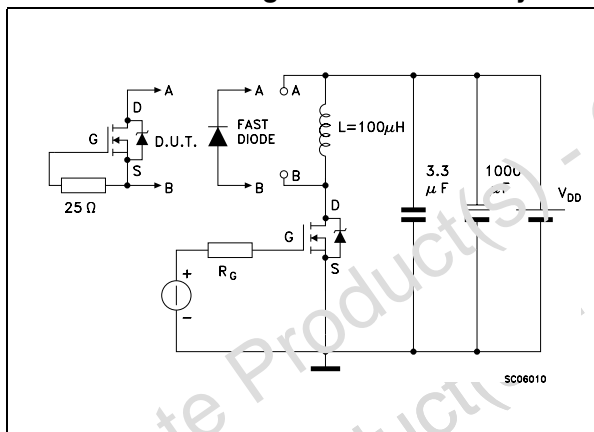


Figure 16. Unclamped Inductive load test circuit

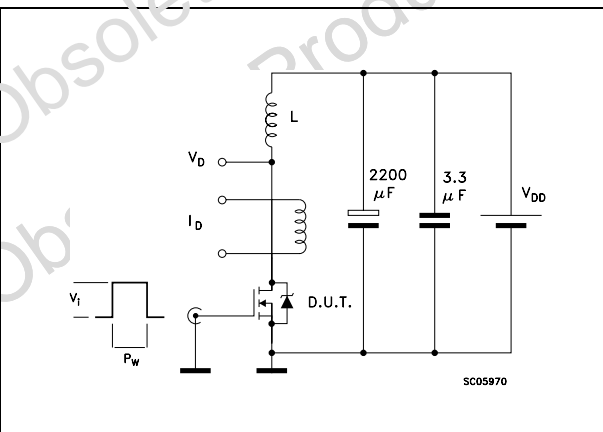


Figure 17. Unclamped inductive waveform

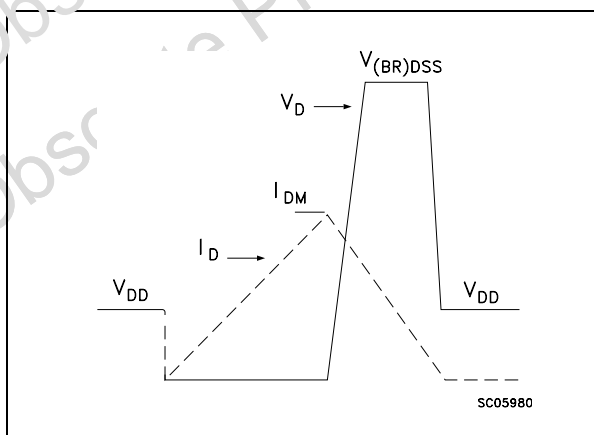
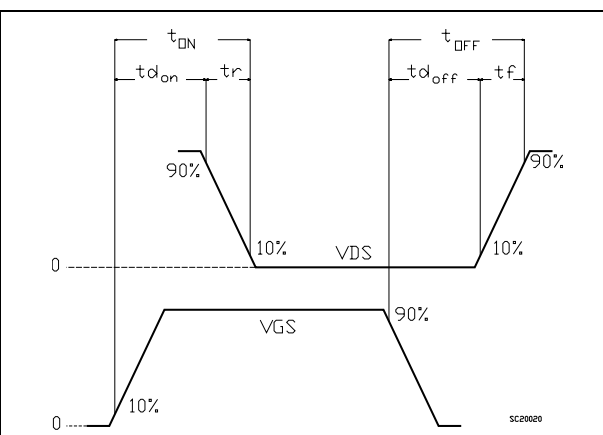


Figure 18. Switching time waveform



STS17NF3LL**Package mechanical data**

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

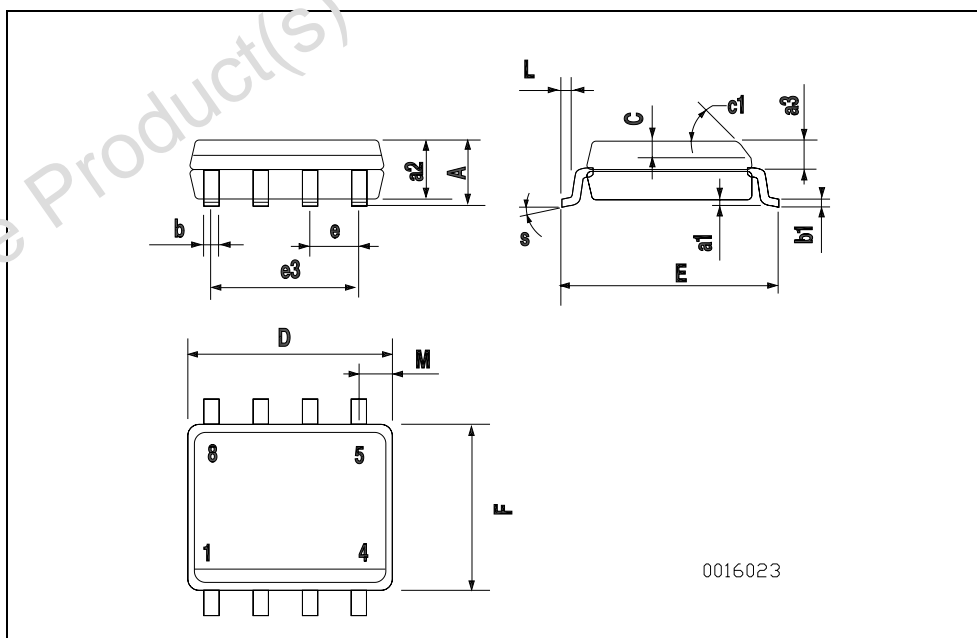
Obsolete Product(s) - Obsolete Product(s)
Obsolete Product(s) - Obsolete Product(s)

Package mechanical data

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SO-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1	45 (typ.)					
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S	8 (max.)					



5 Revision history

Table 6. Revision history

Date	Revision	Changes
21-Jun-2004	4	Complete document
04-Oct-2006	5	New template, no content change

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